



### Polyphenylene sulfide

Fortron 1140L4 DW is a 40% glass-reinforced grade that is the strongest and toughest product available. It has been developed for use in drinking water applications. It exhibits excellent heat and chemical resistance, good electrical properties and is inherently flame-retardant. The high hardness and rigidity at elevated temperatures allows for good load bearing performance. This product has good weldability due to the modest filler level. Applications made of this grade are electronical components (i.e. bobbins, lamp housings, brush holders) and various other components requiring strength and resistance to aggressive chemicals (i.e. automotive heaters, pumps, valves, fuel rails, microwave oven rings and distillation column packings).

#### Product information

Product information			
Resin Identification	PPS-GF40		ISO 1043
Part Marking Code	>PPS-GF40<		ISO 11469
·			
Rheological properties			
Moulding shrinkage, parallel	0.3	%	ISO 294-4, 2577
Moulding shrinkage, normal	0.6	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	14700	MPa	ISO 527-1/-2
Tensile stress at break, 5mm/min		MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	1.8		ISO 527-1/-2
Flexural modulus	14500		ISO 178
Flexural strength	280	MPa	ISO 178
Compressive modulus	15000	MPa	ISO 604
Compressive strength		MPa	ISO 604
Charpy impact strength, 23°C		kJ/m²	ISO 179/1eU
Charpy impact strength, -30°C		kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C		kJ/m²	ISO 179/1eA
Charpy notched impact strength, -30°C		kJ/m²	ISO 179/1eA
Izod notched impact strength, 23°C		kJ/m²	ISO 180/1A
Izod notched impact strength, -30°C		kJ/m²	ISO 180/1A
Izod impact strength, 23°C		kJ/m <sup>2</sup>	ISO 180/1U
Izod impact strength, -30°C		kJ/m²	ISO 180/1U
Hardness, Rockwell, M-scale Poisson's ratio	100 0.33 <sup>[C]</sup>		ISO 2039-2
	0.33		
[C]: Calculated			
Thermal properties			
Melting temperature, 10°C/min	280	°C	ISO 11357-1/-3
Glass transition temperature, 10°C/min		°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	270		ISO 75-1/-2
Temperature of deflection under load, 8 MPa	215	°C	ISO 75-1/-2
Ball pressure test	260	-	IEC 60695-10-2
Coefficient of linear thermal expansion (CLTE), parallel	16	E-6/K	ISO 11359-1/-2
Coefficient of linear thermal expansion (CLTE), normal	42	E-6/K	ISO 11359-1/-2
Thermal conductivity, flow	0.47	W/(m K)	ISO 22007-2
Thermal conductivity, crossflow		W/(m K)	ISO 22007-2
-		•	

Printed: 2025-05-30 Page: 1 of 13





ISO 22007-2

# FORTRON® 1140L4 DW

## Polyphenylene sulfide

Thermal conductivity, through plane

Effective thermal diffusivity, flow	2.7E-7	m²/s	ISO 22007-4
Effective thermal diffusivity, crossflow	2.4E-7	m²/s	ISO 22007-4
Effective thermal diffusivity, through plane	2.2E-7	m²/s	ISO 22007-4
Specific heat capacity of melt	1040	J/(kg K)	ISO 22007-4
Flammability			
Burning Behav. at 1.5mm nom. thickn.	V-0	class	IEC 60695-11-10
Thickness tested	1.5	mm	IEC 60695-11-10
Burning Behav. at thickness h	V-0	class	IEC 60695-11-10
Thickness tested	0.38	mm	IEC 60695-11-10
Burning Behav. 5V at thickness h	5VA	class	IEC 60695-11-20
Thickness tested	3	mm	IEC 60695-11-20
Oxygen index	47	%	ISO 4589-1/-2
Glow Wire Flammability Index, 0.4mm	960	°C	IEC 60695-2-12
Glow Wire Ignition Temperature, 0.75mm	825	°C	IEC 60695-2-13
Glow Wire Ignition Temperature, 0.4mm	825	°C	IEC 60695-2-12
Electrical properties			
Relative permittivity, 1MHz	4.1		IEC 62631-2-1
Discipation factor 1MHz		E 1	IEC 60601 0 1

0.39 W/(m K)

Relative permittivity, 1MHz	4.1	IEC 62631-2-1
Dissipation factor, 1MHz	20 E-4	IEC 62631-2-1
Volume resistivity	>1E13 Ohm.m	IEC 62631-3-1
Surface resistivity	6.6E11 Ohm	IEC 62631-3-2
Electric strength	21 <sup>[PV]</sup> kV/mm	IEC 60243-1
Comparative tracking index	125	IEC 60112
Arc Resistance	134 s	UL 746B
[PV]: Preliminary Value		

### Physical/Other properties

Water absorption, 2mm	0.02 %	Sim. to ISO 62
Water absorption, Immersion 24h	0.02 %	Sim. to ISO 62
Density	1600 kg/m³	ISO 1183
Bulk density	720 kg/m <sup>3</sup>	ISO 60

### Injection

Drying Recommended	yes
Drying Temperature	130 °C
Drying Time, Dehumidified Dryer	2-4 h
Processing Moisture Content	≤0.02 %
Melt Temperature Optimum	330 °C
Min. melt temperature	310 °C
Max. melt temperature	340 °C
Screw tangential speed	0.2 - 0.3 m/s
Mold Temperature Optimum	150 °C
Min. mould temperature	140 °C
Max. mould temperature	160 °C
Hold pressure range	30 - 70 MPa
Back pressure	3 MPa

Printed: 2025-05-30 Page: 2 of 13





### Polyphenylene sulfide

#### Characteristics

Processing Injection Moulding

Delivery form Pellets

Additives Release agent

Special characteristics Flame retardant, Heat stabilised or stable to heat, Chemical resistant

#### Additional information

Injection molding

#### Preprocessing

Predrying in a dehumidified air dryer at 130 - 140 degC/3-4 hours is recommended.

#### **Processing**

On injection molding machines with 15-25 D long three-section screws, as are usual in the trade, the FORTRON is processable. A shut-off nozzle is preferred to a free-flow nozzle.

Melt temperature 320-340 degC Mold wall temperature at least 140 degC

A medium injection rate is normally preferred. All mold cavities must be effectively vented.

#### Postprocessing

Tool temperature of at least 135 degC is recommended for parts to achieve maximum crystallizable potential.

#### **Processing Notes**

#### **Pre-Drying**

FORTRON should in principle be predried. Because of the necessary low maximum residual moisture content the use of dry air dryers is recommended. The dew point should be =< -  $30^{\circ}$  C. The time between drying and processing should be as short as possible.

#### Storage

For subsequent storage the material should be stored dry in the dryer until processed (<= 60 h).

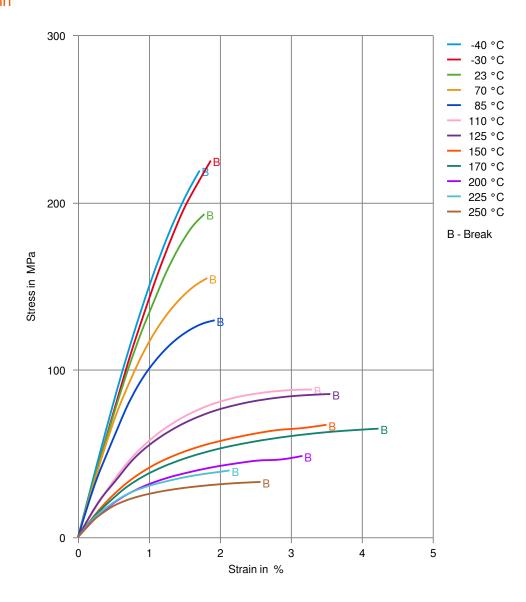
Printed: 2025-05-30 Page: 3 of 13





## Polyphenylene sulfide

#### Stress-strain



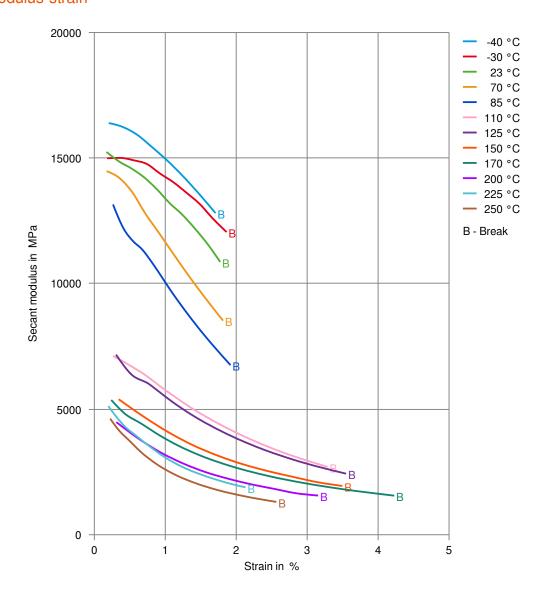
Printed: 2025-05-30 Page: 4 of 13





## Polyphenylene sulfide

#### Secant modulus-strain



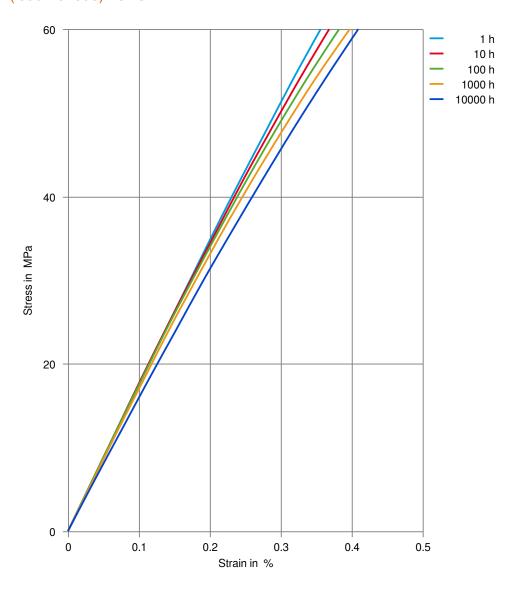
Printed: 2025-05-30 Page: 5 of 13





## Polyphenylene sulfide

Stress-strain (isochronous) 23°C



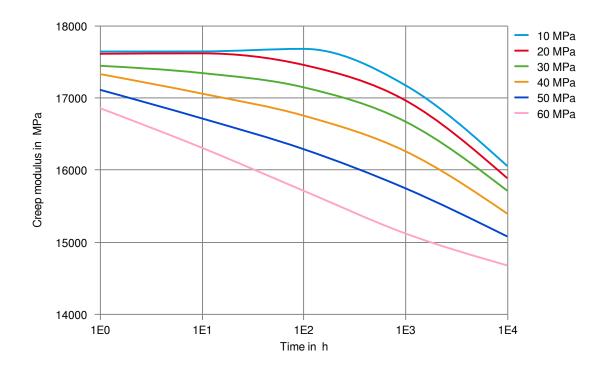
Printed: 2025-05-30 Page: 6 of 13





Polyphenylene sulfide

Creep modulus-time 23°C



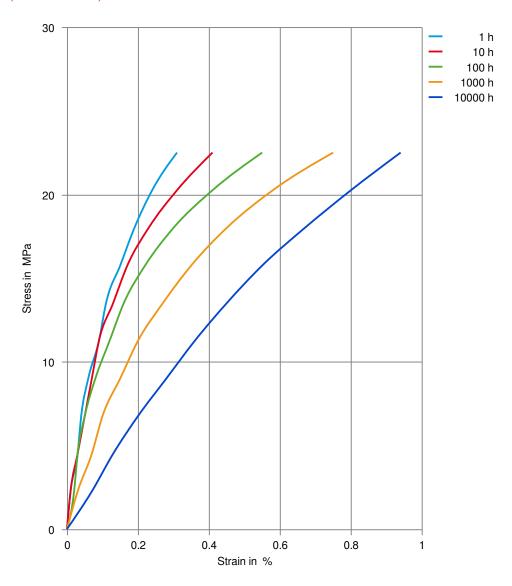
Printed: 2025-05-30 Page: 7 of 13





## Polyphenylene sulfide

Stress-strain (isochronous) 120°C



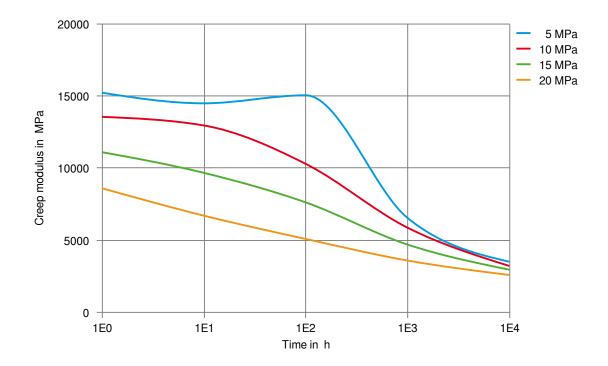
Printed: 2025-05-30 Page: 8 of 13





Polyphenylene sulfide

Creep modulus-time 120°C



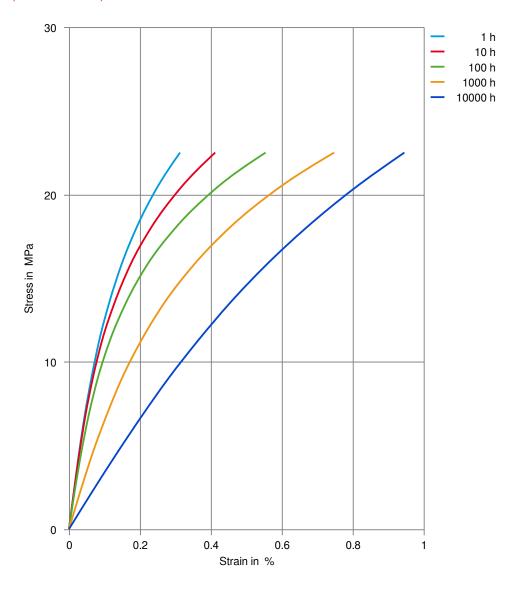
Printed: 2025-05-30 Page: 9 of 13





## Polyphenylene sulfide

Stress-strain (isochronous) 150°C



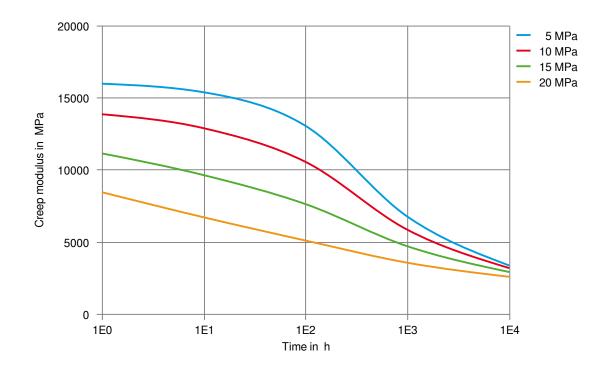
Printed: 2025-05-30 Page: 10 of 13





Polyphenylene sulfide

Creep modulus-time 150°C



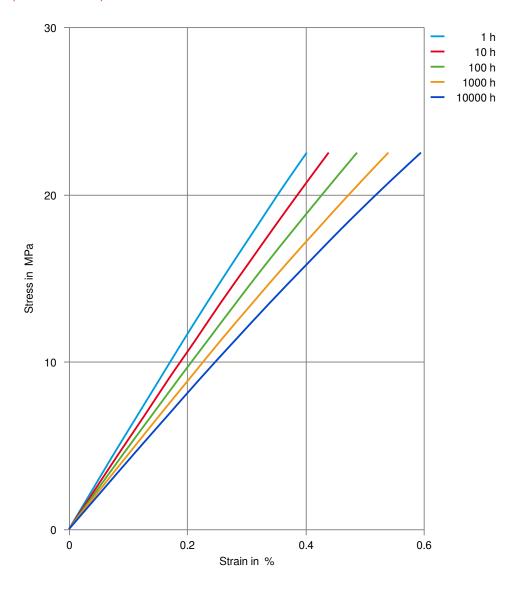
Printed: 2025-05-30 Page: 11 of 13





## Polyphenylene sulfide

Stress-strain (isochronous) 200°C



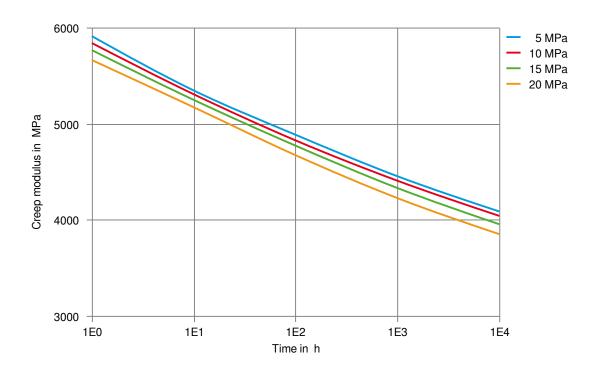
Printed: 2025-05-30 Page: 12 of 13





### Polyphenylene sulfide

Creep modulus-time 200°C



Printed: 2025-05-30 Page: 13 of 13

Revised: 2025-04-08 Source: Celanese Materials Database

NOTICE TO USERS: Values shown are based on testing of laboratory test specimens and represent data that fall within the standard range of properties for natural material. These values alone do not represent a sufficient basis for any part design and are not intended for use in establishing maximum, minimum, or ranges of values for specification purposes. Colourants or other additives may cause significant variations in data values. Properties of moulded parts can be influenced by a wide variety of factors including, but not limited to, material selection, additives, part design, processing conditions and environmental exposure. Other than those products expressly identified as medical grade (including by MT® product designation or otherwise), Celanese's products are not intended for use in medical or dental implants. Regardless of any such product designation, any determination of the suitability of a particular material and part design for any use contemplated by the users and the manner of such use is the sole responsibility of the users, who must assure themselves that the material as subsequently processed meets the needs of their particular product or use. To the best of our knowledge, the information contained in this publication is accurate; however, we do not assume any liability whatsoever for the accuracy and completeness of such information. The information contained in this publication should not be construed as a promise or guarantee of specific properties of our products. It is the sole responsibility of the users to investigate whether any existing patents are infringed by the use of the materials mentioned in this publication. Moreover, there is a need to reduce human exposure to many materials to the lowest practical limits in view of possible adverse effects. To the extent that any hazards may have been mentioned in this publication, we neither suggest nor guarantee that such hazards are the only ones that exist. We recommend that persons intending to rely on any recommendation or to use any e

© 2025 Celanese or its affiliates. All rights reserved. Celanese®, registered C-ball design and all other trademarks identified herein with ®, TM, SM, unless otherwise noted, are trademarks of Celanese or its affiliates. Fortron is a registered trademark of Fortron Industries LLC.